

#### **Description**

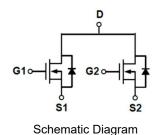
#### **Features**

- 20V, 5A
  - $R_{DS(ON)}$ <26m $\Omega$  @  $V_{GS}$  =4.5V
  - $R_{DS(ON)}$ <34m $\Omega$  @  $V_{GS}$  =2.5V
- Advanced Trench Technology
- Provide Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead free product is acquired

#### **Application**

- Load Switch
- PWM Application
- Power management





### **Package Marking and Ordering Information**

| Device Marking | Device   | OUTLINE | Device Package | Reel Size | Reel<br>(PCS) | Per Carton<br>(PCS) |
|----------------|----------|---------|----------------|-----------|---------------|---------------------|
| VSM8205A-S6    | VSM8205A | TAPING  | SOT-23-6       | 7inch     | 3000          | 180000              |

## **Absolute Maximum Ratings** (T<sub>A</sub>=25 ℃ unless otherwise specified)

| Symbol                            | Parameter                               |                        | Max.        | Units      |
|-----------------------------------|---|------------------------|-------------|------------|
| V <sub>DSS</sub>                  | Drain-Source Voltage                    |                        | 20          | V          |
| $V_{GSS}$                         | Gate-Source Voltage                     |                        | ±12         | V          |
| I <sub>D</sub>                    | Continuous Drain Current                | T <sub>A</sub> = 25℃   | 5           | Α          |
|                                   |   | T <sub>A</sub> = 100°C | 3.2         | Α          |
| $I_{DM}$                          | Pulsed Drain Current note1              |                        | 20          | Α          |
| P <sub>D</sub>                    | Power Dissipation                       | T <sub>A</sub> = 25°C  | 1.5         | W          |
| $R_{\theta JA}$                   | Thermal Resistance, Junction to Ambient |                        | 83.3        | °C/W       |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range |                        | -55 to +150 | $^{\circ}$ |



# **Electrical Characteristics** (T<sub>J</sub>=25°C unless otherwise specified)

| Symbol               | Parameter  | Test Condition                             | Min. | Тур. | Max. | Units |  |  |
|----------------------|--|--|------|------|------|-------|--|--|
| Off Characteristic   |  |  |      |      |      |       |  |  |
| V <sub>(BR)DSS</sub> | Drain-Source Breakdown Voltage                           | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA | 20   | -    | -    | V     |  |  |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current                          | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, | -    | -    | 1.0  | μΑ    |  |  |
| I <sub>GSS</sub>     | Gate to Body Leakage Current                             | V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V | -    | -    | ±100 | nA    |  |  |
| On Charac            | On Characteristics                                       |  |      |      |      |       |  |  |
| V <sub>GS(th)</sub>  | Gate Threshold Voltage                                   | $V_{DS}=V_{GS}$ , $I_{D}=250\mu A$         | 0.5  | 0.66 | 1.2  | V     |  |  |
| В                    | Static Drain-Source on-Resistance                        | V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A  | -    | 18   | 26   | mΩ    |  |  |
| R <sub>DS(on)</sub>  | note2  | $V_{GS}$ =2.5V, $I_D$ =3A                  | -    | 23   | 34   |       |  |  |
| Dynamic C            | Dynamic Characteristics                                  |  |      |      |      |       |  |  |
| C <sub>iss</sub>     | Input Capacitance  |  | -    | 800  | -    | pF    |  |  |
| Coss                 | Output Capacitance                                       | $V_{DS}=10V, V_{GS}=0V,$                   | -    | 155  | -    | pF    |  |  |
| C <sub>rss</sub>     | Reverse Transfer Capacitance                             | f=1.0MHz                                   | -    | 125  | -    | pF    |  |  |
| Qg                   | Total Gate Charge  | \/ -10\/   -24                             | -    | 11   | -    | nC    |  |  |
| Q <sub>gs</sub>      | Gate-Source Charge                                       | $V_{DS}$ =10V, $I_{D}$ =3A, $V_{GS}$ =4.5V | -    | 2.3  | -    | nC    |  |  |
| $Q_{gd}$             | Gate-Drain("Miller") Charge                              | VGS-4.5V                                   | -    | 2.5  | -    | nC    |  |  |
| Switching            | Characteristics  |  |      |      |      |       |  |  |
| t <sub>d(on)</sub>   | Turn-on Delay Time                                       | 101  | -    | 18   | -    | ns    |  |  |
| t <sub>r</sub>       | Turn-on Rise Time  | V <sub>DS</sub> =10V,                      | -    | 5    | -    | ns    |  |  |
| t <sub>d(off)</sub>  | Turn-off Delay Time                                      | $I_D=3A$ , $R_{GEN}=3\Omega$ ,             | -    | 43   | -    | ns    |  |  |
| t <sub>f</sub>       | Turn-off Fall Time                                       | - V <sub>GS</sub> =4.5V                    | -    | 20   | -    | ns    |  |  |
| Drain-Soul           | rce Diode Characteristics and Maxim                      | um Ratings                                 |      |      |      |       |  |  |
| Is                   | Maximum Continuous Drain to Source Diode Forward Current |  |      | -    | 6.5  | Α     |  |  |
| I <sub>SM</sub>      | Maximum Pulsed Drain to Source Diode Forward Current     |  |      | _    | 26   | Α     |  |  |
| V <sub>SD</sub>      | Drain to Source Diode Forward Voltage                    | V <sub>GS</sub> =0V, I <sub>S</sub> =5A    | -    | -    | 1.2  | V     |  |  |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

<sup>2.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



## **Typical Performance Characteristics**

Figure1: Output Characteristics

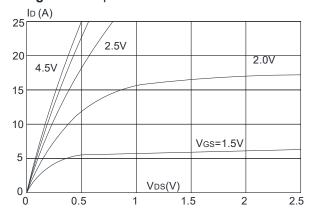


Figure 3:On-resistance vs. Drain Current

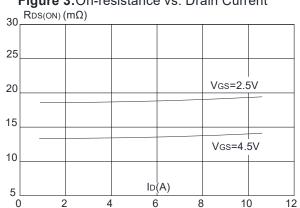


Figure 5: Gate Charge Characteristics

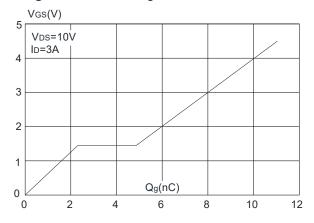


Figure 2: Typical Transfer Characteristics

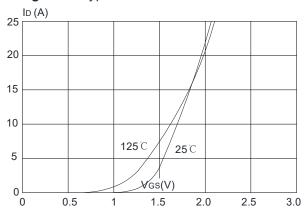


Figure 4: Body Diode Characteristics

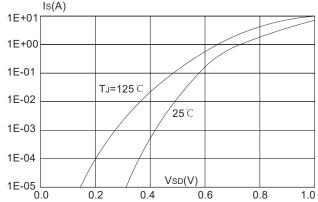
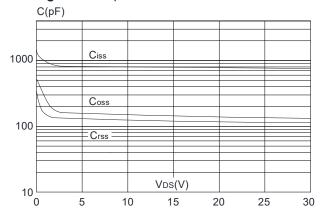


Figure 6: Capacitance Characteristics





**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature

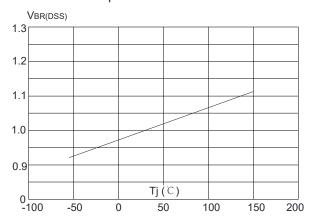
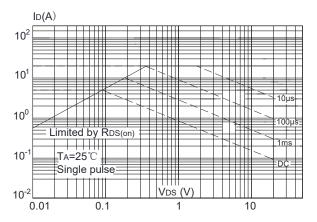
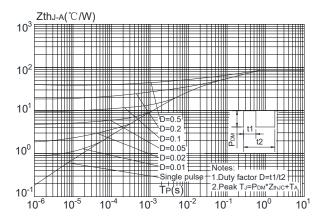


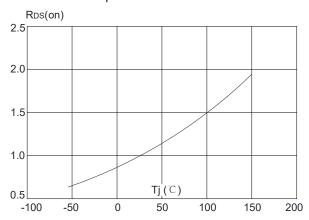
Figure 9: Maximum Safe Operating Area



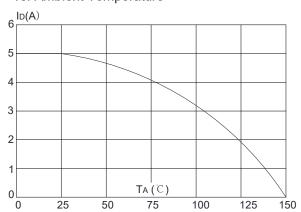
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature





## **Test Circuit**

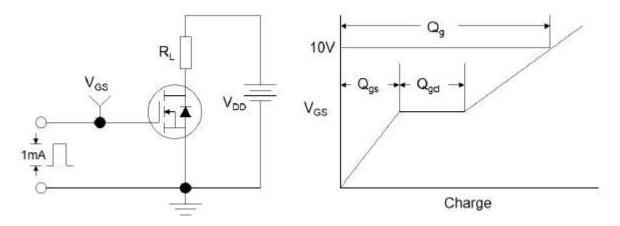


Figure1:Gate Charge Test Circuit & Waveform

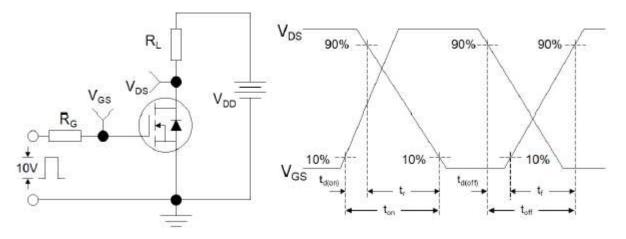


Figure 2: Resistive Switching Test Circuit & Waveforms

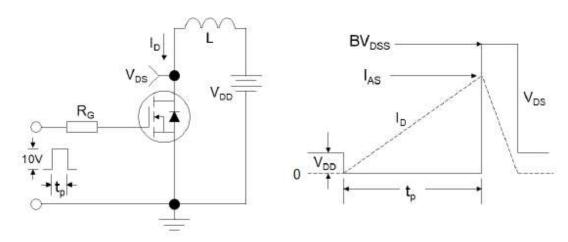


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms